

Form PTO-1595 (Rev. 09-04)
OMB No. 0651-0027 (exp. 6/30/2005)

U.S. DEPARTMENT OF COMMERCE
United States Patent and Trademark Office

RECORDATION FORM COVER SHEET

PATENTS ONLY

To the Director of the U.S. Patent and Trademark Office. Please record the attached documents or the new address(es) below.

1. Name of conveying party(ies)/Execution Date(s):

YUKIO ISOBE (02/25/2008), KENICHIRO
ARIDOME (02/25/2008), NAOKI MORIMOTO
(02/25/2008), ATSUSHI MAE (02/25/2008),
AND

Execution Date(s) in parentheses after inventor name

Additional name(s) of conveying party(ies) attached? Yes No

2. Name and address of receiving party(ies)

Name: SONY CORPORATION

Internal Address: _____

Street Address: _____

1-7-1 Konan, Minato-ku
Tokyo
108-0075
JAPAN

City: _____

State: _____

Country: _____ Zip: _____

Additional name(s) & address(es) attached? Yes No

3. Nature of Conveyance:

- Assignment Merger
- Security Agreement Change of Name
- Government Interest Assignment
- Executive Order 9424, Confirmatory License
- Other _____

4. Application or patent number(s):

A. Patent Application No.(s)
11/992,885

This document is being filed together with a new application.

B. Patent No.(s)

Additional numbers attached? Yes No

5. Name and address to whom correspondence concerning document should be mailed:

Name: Dennis M. Smid, Esq.
LENER, DAVID, LITTENBERG,
KRUMHOLZ & MENTLIK, LLP

Internal Address: Atty. Dkt.: SONYJP 3.3-1432

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Phone Number: (908) 518-6374

Fax Number: (908) 654-0415

Email Address: dsmid@ldlkm.com

6. Total number of applications and patents involved:

1

7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00

Authorized to be charged by credit card

Authorized to be charged to deposit account

Enclosed

None required (government interest not affecting title)

8. Payment Information

a. Credit Card Last 4 Numbers _____
Expiration Date _____

b. Deposit Account Number 12-1095

Authorized User Name Dennis M. Smid, Esq.

9. Signature:



Signature

August 31, 2010

Date

Dennis M. Smid, Esq. - 34,930
Name of Person Signing

Total number of pages including cover sheet, attachments, and documents:

4

CH \$40.00 121095 11992885

Form PTO-1595	RECORDATION FORM COVER SHEET (continued)		
Additional Conveying Party(ies)/Execution Date(s) (1. Continued): Tetsuhiro Maeda (02/25/2008)			
Additional Assignees (2. Continued): Assignee Name: _____ Internal Address: _____ Street Address: _____ City: _____ State: _____ Country: _____ Zip: _____ Assignee Name: _____ Internal Address: _____ Street Address: _____ City: _____ State: _____ Country: _____ Zip: _____ Assignee Name: _____ Internal Address: _____ Street Address: _____ City: _____ State: _____ Country: _____ Zip: _____			
Additional Applications and/or Patents (4. Continued): <table style="width: 100%; border: none;"> <tr> <td style="width: 50%; border: none; vertical-align: top;"> Additional Patent Application Numbers 4A. Continued: </td> <td style="width: 50%; border: none; vertical-align: top;"> Additional Patent Numbers 4B. Continued: </td> </tr> </table> <div style="text-align: right; margin-top: 20px;"> Additional numbers attached? <input type="checkbox"/> Yes <input type="checkbox"/> No </div>		Additional Patent Application Numbers 4A. Continued:	Additional Patent Numbers 4B. Continued:
Additional Patent Application Numbers 4A. Continued:	Additional Patent Numbers 4B. Continued:		

Docket No.: SONYJP 3.3-1432
 Sony Ref. No.: S07P1023US00

ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in:

RECORDING APPARATUS, RECORDING METHOD, AND RECORDING PROGRAM, AND IMAGE CAPTURING APPARATUS, IMAGE CAPTURING METHOD, AND IMAGE CAPTURING PROGRAM

for which an International Application was filed on 25 July 2007, PCT/JP2007/065038, designating the United States;

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 1-7-1 Konan, Minato-ku, Tokyo, Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, my entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the application number and filing date of this application in the spaces that follow: Application Number: _____; Filing Date: _____

This assignment executed on the dates indicated below.

Yukio ISOBE

Name of First or Sole Inventor

Execution Date of U.S. Patent Application

Kanagawa, Japan

Residence of First or Sole Inventor

Yukio Isobe
 Signature of First or Sole Inventor

February 25 2008
 Date of this Assignment

Docket No.: SONYJP 3.3-1432

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Kenichiro ARIDOME

Name of Second Joint Inventor

Execution Date of U.S. Patent Application

Kanagawa, Japan

Residence of Second Joint Inventor

Kenichiro Aridome

Signature of Second Joint Inventor

February 25, 2008

Date of this Assignment

Naoki MORIMOTO

Name of Third Joint Inventor

Execution Date of U.S. Patent Application

Tokyo, Japan

Residence of Third Joint Inventor

Naoki Morimoto

Signature of Third Joint Inventor

February 25, 2008

Date of this Assignment

Atsushi MAE

Name of Fourth Joint Inventor

Execution Date of U.S. Patent Application

Kanagawa, Japan

Residence of Fourth Joint Inventor

Atsushi Mae

Signature of Fourth Joint Inventor

Feb. 25, 2008

Date of this Assignment

Tetsuhiro MAEDA

Name of Fifth Joint Inventor

Execution Date of U.S. Patent Application

Kanagawa, Japan

Residence of Fifth Joint Inventor

Tetsuhiro Maeda

Signature of Fifth Joint Inventor

February 25, 2008

Date of this Assignment